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LIGHT



Photo Transistor Diode Specification

●Commodity: Photo Transistor

●Ic(on) Bin Code (V_{CE}=5V, Ee=1mW/cm²

	BIN CODE	Min. (mA)	Max. (mA)
	X2	3.7	4.4
	Х3	4.4	5.3

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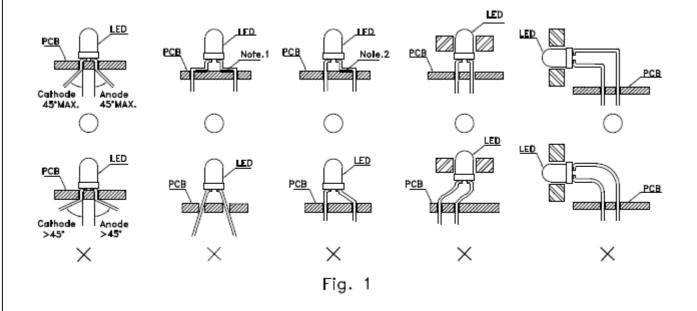
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			LOOD DOOD Of



LED MOUNTING METHOD

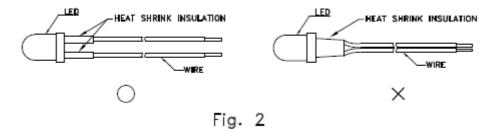
LIGHT

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures (Fig.1).

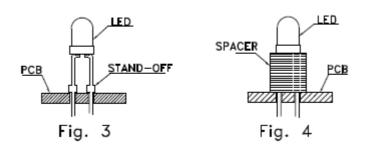


Note 1-2: Do not route PCB trace in the contact area between the lead frame and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit (Fig.2).



3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



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